

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Product image**

























High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

# General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.08 mm, Number of poles: 5, 180°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1838240000</u>
Туре	SL-SMT 5.08HC/05/180G 3.2SN BK BX
GTIN (EAN)	4032248348305
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Вох

Creation date February 5, 2024 10:44:31 AM CET



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# **Technical data**

# **Dimensions and weights**

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Width	27.3 mm
Width (inches)	1.075 inch	Net weight	2.74 g

# **System specifications**

Product family	OMNIMATE Signal - series	Type of connection	
•	BL/SL 5.08	,,	Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		5.08 mm
Pitch in inches (P)	0.2 "	Outgoing elbow	180°
Number of poles	5	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (D)+ 0,1 mm		L1 in mm	20.32 mm
L1 in inches	0.8 "	Number of rows	1
Pin series quantity		Touch-safe protection acc. to DIN VDE	finger-safe unplugged/
	1	57 106	back-of-hand-safe plugged
Touch-safe protection acc. to DIN VDE	IP20 plugged/ IP10	Protection degree	
0470	unplugged		IP20
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	9 N	Pulling force/pole, max.	7 N

#### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Ctava wa tawawawatuwa wain	
Layor or actare or prag correct	13 µm m / 24 µm 3n	Storage temperature, min.	
Layer of actars of plag contact	matt	Storage temperature, min.	-40 °C
Storage temperature, max.		Operating temperature, min.	-40 °C -50 °C
	matt		

# Rated data acc. to IEC

tested acc. to standard	IFC 60664 1 IFC 61094	Rated current, min. number of poles	27.5 A
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	19 A	(Tu=40°C)	24 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	16.5 A	pollution degree II/2	400 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	320 V	pollution degree III/3	250 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	4 kV	class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage			
class/ contamination degree III/3	4 kV		



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167 mm

42 mm

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# **Technical data**

#### Rated data acc. to CSA

Institute (CSA)	<b>€</b>	Certificate No. (CSA)	
B. J. J. (II. B. (2001)	2001/	D. J. H. (11 D. (200)	200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group D / CSA)		Reference to approval values	Specifications are maximum values, details -
	18.5 A		see approval certificate.

#### Rated data acc. to UL 1059

Institute (UR)	<i>21</i> 7.	Certificate No. (UR)	
			E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

### **Packing**

Packaging VPE width

Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
ECLASS 12.0	27-46-02-01	ECLASS 13.0	27460201

VPE length

VPE height

Box

69 mm



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# **Technical data**

#### Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Gold-plated contact surfaces on request
	Rated current related to rated cross-section & min. No. of poles.
	• Diameter of solder eyelet D = 1.4+0.1mm
	• Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles
	• P on drawing = pitch
	<ul> <li>Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> </ul>
	<ul> <li>In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC).</li> <li>During designated use, connectors are not allowed to be engaged or disengaged when live or under load</li> </ul>
	<ul> <li>Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36</li> </ul>

#### **Approvals**

Approvals



months

ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

# **Downloads**

Approval/Certificate/Document of	CB Certificate
Conformity	CB Testreport
·	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN
	MB SMT EN
	FL DRIVES DE
	MB DEVICE MANUF. EN
	FL BUILDING SAFETY EN
	FL APPL LED LIGHTING EN
	FL INDUSTR.CONTROLS EN
	FL MACHINE SAFETY EN
	FL HEATING ELECTR EN
	<u>FL APPL_INVERTER EN</u>
	FL_BASE_STATION_EN
	FL ELEVATOR EN
	FL POWER SUPPLY EN
	FL 72H SAMPLE SER EN
	PO OMNIMATE EN
	PO OMNIMATE EN
White paper surface mount technology	<u>Download Whitepaper</u>



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# **Drawings**

# **Product image**



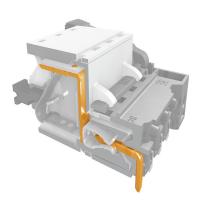
# **Dimensional drawing**





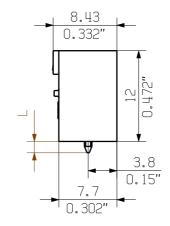


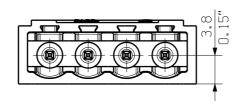
### **Product benefits**

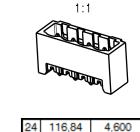


Safe power transmission Proven properties

L1+8.28 ±0.1 L1+0.326"' 0.047" L1







116,84

111,76

106,68

101,60 96,52

91,44

86,36

81,28

76,20

71,12

66,04

60,96

55,88

50,80

45,72

40,64

35,56

4,400 4,200

4,000

3,800

3,600

3,400

3,200

3,000

2,800

2,600

2,400

2,200

2,000

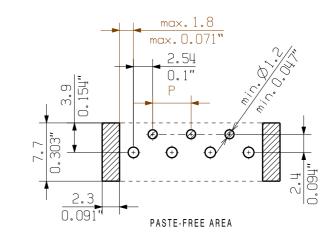
1,800

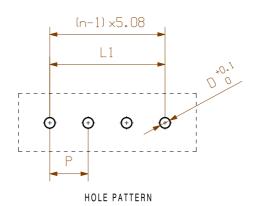
1,600

1,400

Issue no

7280





D = 1.4/0.055" or 1.5/0.059"(REFLOW SOLDERING) RECOMMENDATION FOR AUTOMATIC ASSEMBLY (1.4 mm FOR n = 2...8 / 1.5 mm for n = 9...24)

Checked

Approved

n = POLZAH/ NO OF POLES

P = RASTER/PITCH

Scale: 2:1

Supersedes:

SHOWN: SL-SMT 5.08HC/04/180 G

STIETL AFNGE I	TOLERANZ	n	L1 [mm]	L1 [Inch]
4,5	-0,3	2	5,08	0,200
A E	0,1	3	10,16	0,400
3,2	-0,3	4	15,24	0,600
2.0	0,1	_	-	
- 4 -	-0,3	5	20,32	0,800
1,5	0,0	6	25,40	1,000
	0.0	7	30,48	1,200

MALE HEADER

Product file: SL-SMT 5.08HC

Cat.no.: DIN ISO 2768-m Weidmüller 🐔 30.07.18 HERTEL\_S 00 Drawing no. Modification Sheet 02 of 04 sheets Name Date 30.11.2007 | HELIS\_MA SL-SMT 5.08HC/../180... Drawn HERTEL\_S Responsible STIFTLEISTE

01.08.2018 KOCH\_JG

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For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.



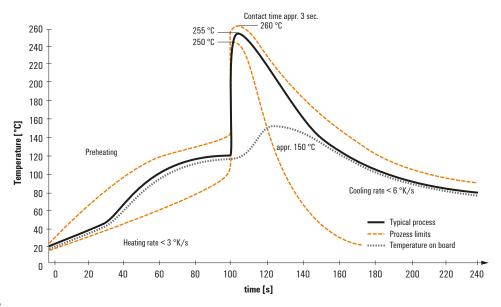
# Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

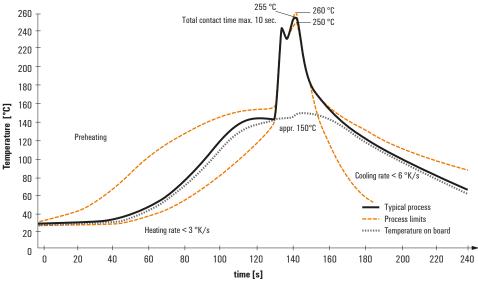
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# Single Wave:



#### **Double Wave:**



# Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

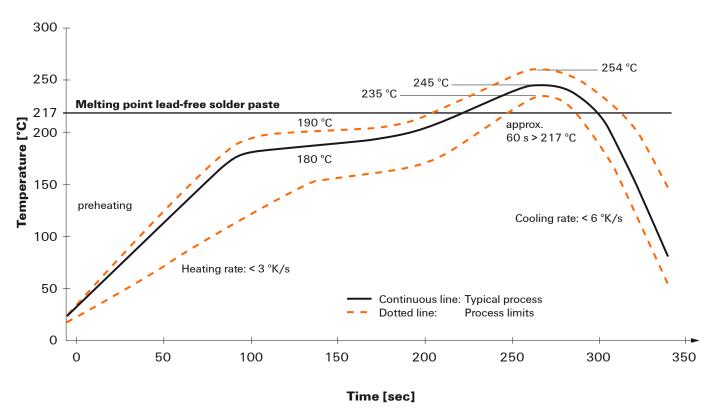


# Recommended reflow soldering profile

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# Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated′. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.